

# Cascadable Silicon Bipolar MMIC Amplifier

# Technical Data

#### **MSA-0304**

#### Features

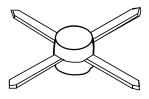
- Cascadable 50  $\Omega$  Gain Block
- **3 dB Bandwidth:** DC to 1.6 GHz
- 11.0 dB Typical Gain at 1.0 GHz
- \* 10.0 dBm Typical  $P_{1 dB}$  at 1.0 GHz
- Unconditionally Stable (k>1)
- Low Cost Plastic Package

#### Description

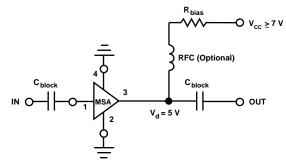
The MSA-0304 is a high performance silicon bipolar Monolithic Microwave Integrated Circuit (MMIC) housed in a low cost plastic package. This MMIC is designed for use as a general purpose  $50 \Omega$  gain block. Typical applications include narrow and broad band IF and RF amplifiers in industrial and military applications.

The MSA-series is fabricated using HP's 10 GHz f<sub>T</sub>, 25 GHz f<sub>MAX</sub>, silicon bipolar MMIC process which uses nitride self-alignment, ion implantation, and gold metallization to achieve excellent performance, uniformity and reliability. The use of an external bias resistor for temperature and current stability also allows bias flexibility.

### **04A Plastic Package**



#### **Typical Biasing Configuration**



### MSA-0304 Absolute Maximum Ratings

Parameter	Absolute Maximum <sup>[1]</sup>		
Device Current	70 mA		
Power Dissipation <sup>[2,3]</sup>	400 mW		
RF Input Power	+13dBm		
Junction Temperature	150°C		
Storage Temperature	−65 to 150°C		

Thermal Resistance<sup>[2,4]</sup>:  $\theta_{jc} = 100^{\circ}C/W$ 

#### Notes:

- Permanent damage may occur if any of these limits are exceeded.
  The second second
- 2.  $T_{CASE} = 25^{\circ}C.$
- 3. Derate at 10 mW/°C for  $T_{\rm C} > 110$  °C.
- 4. See MEASUREMENTS section "Thermal Resistance" for more information.

Symbol	Parameters and Test Conditions: $I_{d}$ = 35 mA, $Z_{0}$ = 50 $\Omega$		Units	Min.	Тур.	Max.
GP	Power Gain $( S_{21} ^2)$	f = 0.1  GHz f = 0.5  GHz f = 1.0  GHz	dB	10.0	12.5 12.0 11.0	
$\Delta G_P$	Gain Flatness	f = 0.1  to  1.3  GHz	dB		± 1.0	
f <sub>3 dB</sub>	3 dB Bandwidth		GHz		1.6	
VSWR	Input VSWR	f = 0.1  to  3.0  GHz			1.3:1	
	Output VSWR	f = 0.1  to  3.0  GHz			1.6:1	
NF	$50 \Omega$ Noise Figure	f = 1.0 GHz	dB		6.0	
P <sub>1 dB</sub>	Output Power at 1 dB Gain Compression	f = 1.0 GHz	dBm		10.0	
IP <sub>3</sub>	Third Order Intercept Point	f = 1.0 GHz	dBm		23.0	
tD	Group Delay	f = 1.0 GHz	psec		150	
Vd	Device Voltage		V	4.5	5.0	5.5
dV/dT	Device Voltage Temperature Coefficient		mV/°C		-8.0	

# Electrical Specifications<sup>[1]</sup>, $T_A = 25^{\circ}C$

Note:

1. The recommended operating current range for this device is 20 to 50 mA. Typical performance as a function of current is on the following page.

 $S_{21}$  $\mathbf{S}_{22}$  $S_{11}$  $S_{12}$ Freq. dB GHz Mag Ang Mag Ang dB Mag Ang Mag Ang 0.1 .10 173 12.54.24 173 -18.5.120 3 .12 -13 0.2 .10 162 12.54.21 167 -18.2.123 4 .12 -24 .09 142 12.2 4.08 -18.0.125 7 .13 0.4 153 -46.08 11.9 -17.8.128 0.6 127 3.93 141 10 .15 -64 3.76 -17.30.8 .07 110 11.5130 .136 14 .16 -781.0 .06 92 11.1 3.58 118 -16.8.144 16 .17 -911.5 .03 58 10.0 3.15 93 -15.5.169 19 .19 -1172.0 .03 175 8.8 2.7671-14.1.197 18 .20 -1392.5.05 163 7.8 2.4655-13.2.218 18 .21 -158.22 3.0 .12 148 6.8 2.20 38 -12.2.246 15 -174

20

-28

-56

3

-11.2

-10.6

-10.2

-9.9

.275

.296

.319

.310

7

1

-15

-31

.24

.26

.29

.37

171

158

128

94

MSA-0304 Typical Scattering Parameters ( $Z_0 = 50 \Omega$ ,  $T_A = 25^{\circ}C$ ,  $I_d = 35 mA$ )

A model for this device is available in the DEVICE MODELS section.

5.9

5.0

3.0

0.4

1.98

1.77

1.41

1.05

129

110

77

52

## Typical Performance, $T_A = 25^{\circ}C$

.19

.26

.44

.63

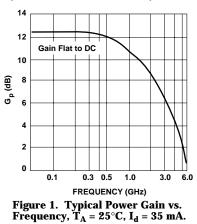
(unless otherwise noted)

3.5

4.0

5.0

6.0



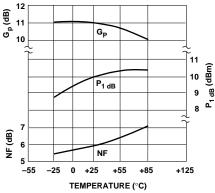


Figure 4. Output Power at 1 dB Gain Compression, NF and Power Gain vs. Case Temperature, f = 1.0 GHz,  $I_d$ =35mA.

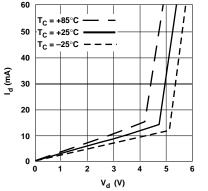


Figure 2. Device Current vs. Voltage.

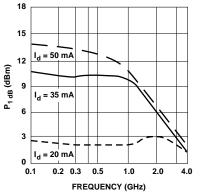
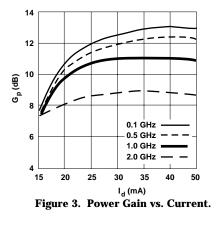
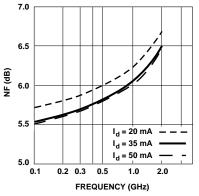


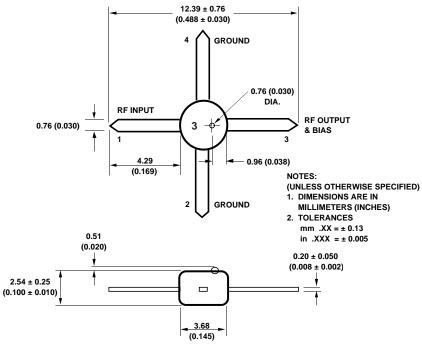
Figure 5. Output Power at 1 dB Gain Compression vs. Frequency.







## **04A Plastic Package Dimensions**



DIMENSIONS ARE IN MILLIMETERS (INCHES).